

RECORDING HEAD TO OPTIMIZE HIGH DENSITY RECORDING

Background of the Invention

The present invention relates to design of a magnetic recording head which optimizes high density longitudinal recording.

A magnetic recording head produces a magnetic field which has transverse, vertical, and longitudinal components. The longitudinal component is directed along the recording medium direction of motion, the vertical component is normal to the plane of the medium, and the transverse component is oriented along the track width direction. Recording heads are ordinarily designed such that the strength of the head field at the medium mid-plane directly beneath the gap center line of the head is about two to three times the value of the medium coercivity, where coercivity is the amount of field strength necessary to switch the orientation of the magnetization in the medium. A track is created during the head write cycle by the downstream magnetic field of the head where it equals the coercivity threshold of the medium. When a data bit is written, the medium magnetic orientation is reversed on the track at an assigned location. Each of the sections of the medium where the magnetization has been reversed is referred to individually as a "transition". The width of the track defined on the recording medium will be approximately equal to the width of the head gap.

A typical recording head will include two pole pieces with the gap defined therebetween. The actual recording of a transition occurs somewhat downstream along the direction of the moving medium, approximately 0.25 microns into the second pole piece in the longitudinal direction.



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The transverse field component from the head is comparable in magnitude to the longitudinal field component at the sides of the head, the latter known as the fringe zones. For thin film media, the two in-plane components of the head field, i.e. the transverse and longitudinal components, add vectorially in their impact on the transition. In the mid-section of the track, only the longitudinal field exists and hence it produces an essentially straight line transition perpendicular to the direction of medium movement. However, the recorded transition is not parallel to the gap in the fringe zones because of the varying degrees of interaction between the two in-plane components. In fact, at the fringe zones the transition will be perturbed at its ends where hooks are defined protruding further into the downstream section of the medium. These hooks cause inter-symbol interference during the writing of closely spaced bits and can cause lateral asymmetry in the readback pulse. In addition, the medium coercivity may be degraded when the perpendicular (vertical) component of the head field that is imposed upon the medium is large.

In the known processes used to manufacture recording heads of the type discussed above, the second pole is normally configured to be as wide as or about one to three microns narrower than the first pole at the gap. Such designs suffer from the fringe zone and vertical field effects problems discussed above during longitudinal recording on thin film media.

Summary of the Invention

In one aspect of the invention, a method is disclosed in which a recording head having two pole pieces is designed so as not to produce hooks in a recorded transition. In such arrangement, the transverse head field components are substantially reduced in the recorded zone by producing a second pole piece which is

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wider in cross-section at its tip than the first pole piece tip cross-section.

In another aspect of the invention, where a magnetic recording head has two pole pieces defining a gap section or layer therebetween, the second pole piece is configured to be perhaps about one or more microns wider than the first pole piece. In this arrangement, the transverse fields at the fringe zones are reduced by approximately 35% and also the contours of the longitudinal component of the head field become parallel to the gap at the fringe zones. Such a field distribution eliminates the hooks at the ends of the transition and permits the transition to be defined parallel to the gap at such locations. A straight transition prevents the nonlinear interference between a current transition and the previous transition during the writing process.

In another aspect of the present invention, where a magnetic recording head has two pole pieces defining a gap layer therebetween, the second pole piece is configured to be perhaps about one or more microns wider than the first pole piece. In this arrangement, the transverse fields at the fringe zones are reduced by approximately 35%, compared to where the first pole piece is wider than the second pole piece, and also the contours of the longitudinal component of the head field become parallel to the gap at such locations. This field distribution eliminates the hooks. The transition now becomes parallel to the gap. The vertical component of the head field at the recording zone is also reduced by 35% compared to the field produced by the current designs. Therefore, the resultant head field at the recording zone is only about 50° out-of-plane and does not cause an appreciable degradation in the in-plane

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switching field of high coercivity media, thus providing sharper transitions.

In an alternative configuration of the present invention, a third pole piece, which is both thin and saturable at the tip, is embedded within the gap. This third pole is saturated and is effectively inoperative during the write cycle, but is not saturated and effectively dominates operation during the readback cycle. As a result of the operation and configuration of the third pole, the readback waveform will be nearly symmetrical.

In another aspect of the invention, a magnetic transducer, includes at least a functionally first pole, and at least a functionally second pole; the tip of the second pole being formable over the tip of the first pole regardless of relative pole width and alignment.

The pole tips may define a portion of an air-bearing surface, with the first pole disposed to interact with a magnetic medium before the second pole interacts with the medium, thus defining a longitudinal operational direction for the head, the poles being separated by a gap section, the gap section's width running substantially perpendicular to the longitudinal direction, and the gap section being at least as wide as the second pole tip is wide.

Preferably the second pole is at least one micron wider than the first pole. The top surface of the gap section and the first pole can form a planarized work area wider than the first pole. The poles form together into a single structure and are connected distal to the tips defining a yoke, the yoke including a coil structure having at least a first and a second lead, the leads coupleable to a source of electrical energy to complete an energization circuit.

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In yet another aspect of the invention, a magnetic head with reduced topographical steps/edges and reduced resultant spurious reflections during lithographic processing, includes a substrate, an insulating layer over the substrate, first pole piece upon the layer, a second pole piece, a gap section, the gap section intermediate and coupled to the pole pieces, and the gap section being at least about as wide as the second pole piece and at least as wide as the first pole piece. Preferably, a planarizing layer is defined upon the first pole piece, whereby the first pole piece plus the planarizing layer is at least about as wide as the second pole piece. The planarizing layer can be Al_2O_3 , SiO_2 , or photoresist material, for example.

In still another aspect of the present invention, a method for forming the poles of a thin film head, the head having at least two poles separated by a gap section, includes the steps of forming a planarizing layer at the first of the poles at its tip whereby a uniform planar area can be defined at the pole tip and the planarizing layer, forming the gap section coupled to the uniform planar area, and forming the second pole coupled to the gap section. The planarizing layer may include hard-baked photoresist material.

This process may include forming a layer of insulating material adjacent to and over the first pole and lapping the insulating material such that the top surface of the first pole and the insulating material conform to a single plane whereby the uniform planar area is defined. The planarizing layer may be Al_2O_3 , SiO_2 , or polyimide, for example.

In further aspect of the invention, in fabrication of a multilayer magnetic device, where a first structure is formed on a workpiece and serves as a base for a second structure, a process of rendering the surface of

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the first structure capable of supporting the second structure even if the second structure is equal to or wider than the first structure, and eliminating step/edges and spurious reflections thereby, includes the steps of: applying a leveling material over the surface of the first structure; photo patterning the leveling material; exposing and developing a desired portion of the first structure; and baking the workpiece and forming a planarized plateau across and beyond the surface of the first structure. The leveling material may be photoresist or polyimide, for example. An embodiment of the process may be characterized in that the formed structure is a first pole of a magnetic transducer, wherein the leveling material is positive photoresist and is photo-patterned using a resist border mask, and wherein a resist border is retained extending over the first pole at least at the pole tip region after exposure and development of the photoresist. Preferably, the border mask inner dimension is slightly smaller than that of the plated pole tip width and forms a shoulder over the first pole

Preferably, the photoresist is hard-baked at a temperature of approximately 265°C or the polyimide is hard-baked at a temperature of approximately 350°C. This process may include applying a vacuum with a 10 cubic feet per hour nitrogen backfill in a magnetic field.

Preferably, the leveling compound overlaps the edges of the first structure by approximately one-quarter to one-half micron. Preferably, step/edges are eliminated by the planarized plateau.

In an additional aspect of the invention, in a head having a gap layer extending over and possibly beyond the sides of a pole, a method for improving gap layer uniformity by preventing thinning of the gap layer at the side corners of the pole during gap layer

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formation, includes the steps of: forming the pole on a substrate; applying a leveling material over and beyond the surface of the pole; and forming the gap layer with the leveling material over and possibly extending beyond the sides of pole.

Other advantages and features will become apparent from the following description of the preferred embodiment and from the claims.

Brief Description of the Drawings

Fig. 1 is a graphical representation of a typical waveform generated by a thin film recording head reading a transition from a magnetic storage medium.

Fig. 2 is a graphical representation of the vectorial sum of the in-plane magnetic field components from different head pole tip geometries, as experienced at the medium mid-surface.

Fig. 3 is a cross-sectional schematic view of a preferred embodiment of the present invention.

Fig. 4A-D show in cross-sectional view the process of planarization of P1 pole in practice of the invention.

Description of the Preferred Embodiment

A typical waveform generated by a thin film magnetic recording head reading a transition from a magnetic medium is shown in the graphical representation of Fig. 1. It will be noted that pulse 10 is defined by a leading half 12 and a trailing half 14, which are not exactly alike. This asymmetry contributes to the variable peak shifts which normally occur when reading a series of transitions from a medium. If the transverse components of waveforms arising from transverse recording were substantially reduced, then the asymmetry and the variability in the peak shifts would be minimized accompanied by an attendant increase in window margin.

Turning now to Fig. 2, which is a graphical representation of a transition from each of three

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recording head pole tip geometries (the first pole greater than, equal to, and less than the second pole), the ill effects of transverse field components upon recording will be described. Upon this graph is

5 superimposed the projection of a magnetic head having two equal width poles, P1 and P2, where adjacent portions of the P1 and P2 pole tips are shown defining gap g. In Fig. 2, distance along the track is shown in an arbitrary scale on the X-axis, while location of a transition

10 relative to location of the gap is also shown in an arbitrary scale on the Y-axis. Furthermore, for each pole tip geometry, only the contour along which the effective in-plane head field equals the coercivity of the medium is shown, which is the active recording region

15 of the head during the write cycle. Also shown is an arrow A which indicates the direction of medium movement, and a center line indication on the right hand vertical axis which signifies that only one half of the transition and the recording head are shown in this figure.

20 When the width of the P2 pole at the air bearing surface is equal to or less than that of P1, the magnitude of the transverse components of the head field are about the same as or are larger than that of the longitudinal components at the fringe zones. Hence, the

25 vectorial sum of these components at the fringe zones will be at the level of the recording medium coercivity further downstream than at the center of the poles. Therefore, the recorded transition will be imparted with hooks at the fringe zones which will interact with the

30 previously recorded bit, causing nonlinear inter-symbol interference at high bit densities. These hooks can be about 1.5 micron wide on either side of the pole edges and can penetrate about 0.3 microns downstream, depending upon the field produced by the head. As the write

35 current through the head is increased, the head field

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influencing the medium increases proportionately and the hooks become more prominent. Therefore, at high bit densities, this nonlinear interference between closely recorded bits causes a reduction of readback amplitude as the write current is increased, a phenomenon which we define as "peakiness."

It will be appreciated that the transverse component of the head field has an asymmetrical distribution along the direction of media motion. Thus, if the transverse head field along one pole is considered as being positive, then the transverse head field along the other pole will be negative. By the principle of reciprocity, it can be shown that the resulting transverse readback waveform is also asymmetrical. This transverse readback waveform is of opposite sign to the longitudinal readback waveform during the leading portion 12 of the central pulse 10 of Fig. 1; it is of the same sign as the longitudinal readback waveform during the trailing portion 14 of Fig. 1. This is a result of the transverse head field during readback near pole P1 being in a direction opposite to the direction of the transverse orientation of the medium magnetization which has been determined during writing by pole P2. Hence, the leading position's "20%-90%" rise time of the resulting readback pulse is reduced, while the trailing portion's "90%-to-20%" fall time is increased, because of the asymmetry in the transverse component of the readback waveform.

When the width of the P2 pole at the air bearing surface is equal to or less than that of P1, the vertical component of the head field is typically about two times the coercivity in the recording zone and the resultant head field is about 60° out-of-plane. When the head field is greater than about 45° or 50° out-of-plane, then the in-plane switching field of high coercivity media is



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reduced. As a result, the longitudinal dimension of the recorded transition is increased which leads to wider pulse widths and lower high frequency amplitudes. Again, as the write current through the head is increased, the
5 vertical field increases, thus causing further degradation of high frequency readback amplitude, i.e., an increase in peakiness.

When the P2 pole is wider than the P1 pole, such as by a few microns, the transverse fields at the fringe
10 zones are reduced, perhaps by 35% in magnitude compared to the above configurations, and also the non-parallel contours of the longitudinal component of the head field become parallel to the gap at the fringe zone. This favorable field distribution eliminates the hooks in the
15 transition, since the transition is now essentially parallel to the gap at all points. A straight transition prevents the nonlinear interference of the current transition with the previous one during the writing cycle, also reducing peakiness.

20 The present invention substantially reduces asymmetry in the resulting readback waveforms by substantially reducing the transverse component during recording when the cross-section of pole P2 is wider than that of P1. Hence, the readback waveform is symmetrical
25 and the magnitudes of the rise and fall times become nearly identical. This symmetry will result in a reduction of peak shift variability.

The present invention also reduces the vertical field at the recording zone such that the resultant head
30 field is less than 50° out-of-plane. As a result, high coercivity media do not suffer any degradation in the magnitude of their in-plane switching field. Therefore, the high frequency readback amplitude remains almost constant with an increase in write current, thus
35 minimizing peakiness.

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Turning now to Fig. 3, which is a cross-sectional schematic view of the pole tips of a preferred recording head 20 of the present invention, it will be appreciated that a geometry is shown where the tip of pole P2 is wider than that of P1 near the gap. In particular, poles P1 and P2 define a gap g , where the width W_0^2 of the P2 pole at the gap is preferably one or more microns wider than the width W_0^1 of the P1 pole at the gap. The additional width of pole P2 over pole P1 at the gap ensures that the transverse component of the head field at the recording zone is minimized. Hence, the medium is essentially magnetized in the longitudinal direction. The write fringing of such a head design is approximately 0.25 microns smaller than that which occurs from a head where the P1 pole is wider than the P2 pole at the gap. We speculate that, for a given track pitch, the width of the P2 pole can be increased slightly, which produces a larger readback signal, thus improving the signal-to-noise ratio of the recording system.

In an alternative configuration of the present invention, a third pole piece P3 may be formed as part of head 20, embedded within the gap layer g . This third head is indicated by the dotted outline within gap layer g as shown in Fig. 3. The third pole piece at its tip is preferably configured to be both thin, less wide than pole P2, and magnetically saturable. It will be appreciated by those skilled in the art that this saturation property can be selectively used by applying appropriate energization to the coil structure at the yoke, whereby the third pole is effectively inoperative during the write cycle. During the read cycle, the third pole is not saturated and effectively dominates reading such that a sharp transition waveform will result.

In known processes for making thin film heads, an insulating base layer of, for example Al_2O_3 , is deposited

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on a ceramic substrate, such as 3M's ALSIMAG 204. A sputtered seed layer, such as NiFe, is applied over this insulating base layer (perhaps employing a metallic adhesion layer). Photoresist is then spun over the seed
5 layer and a pole piece pattern is formed by a photolithographic process. After the resist is developed to form a mask, the first pole piece is plated through the mask. After this plating process is completed (including removing the mask, etching to exposed
10 underlying seed and adhesion layers, remasking the first pole piece, and then etching the plated areas of the pole), a gap layer, such as SiO_2 or Al_2O_3 , is deposited thereon. However, this gap layer does not always adequately cover the P1 pole corners C1 and C2 defined by
15 where the P1 pole top surface 32 meets the side walls 28 and 30, due to the abrupt change in topography at these sidewalls.

In the next steps, a coil structure is formed over the yoke with intermediate layers of insulation, and the
20 second pole piece is formed over this coil structure and the gap layer. During these steps, a considerable thinning of the gap layer occurs, and it can become completely depleted at corners C1 and C2. During plating of the second pole piece, the width of the second pole at
25 its tip is customarily plated to be narrower than the width of the first pole at its tip, in order to allow for microlithographic misalignment tolerances and perhaps also to avoid magnetic shorts occurring between the two poles at junctures C1 and C2 where the gap layer has
30 thinned.

In practice of the present invention, the step at which the gap layer is deposited onto the P1 pole piece is preceded with a planarization process. This planarization involves forming a layer of non-magnetic
35 material adjacent to the P1 pole on either side such that

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there is a uniform base on which the gap layer will be deposited. Hence, as shown in Fig. 3, the planarization layer assumes the same upper plane P as does the upper surface of pole P1.

5 A misaligned P2 pole can hang over the edge of P1 pole, which can result in head pulse asymmetry and peak shift, in addition to increasing the likelihood of pole to pole shorting at the corners C1, C2 of the P1 pole. With a planarized P1 pole, such misalignment will not
10 produce these negative effects, and in addition, present alignment/registration tolerances are relieved. As a result, in addition to the traditional P2 width less than P1 width configuration, it is now possible to
15 conveniently produce magnetic heads where the P2 width is equal to or greater than the P1 width.

 An additional benefit of planarization is that it improves uniformity of the gap layer atop pole P1 because of a more consistent angle of incidence of the pole surface with respect to the deposition stream. Hence,
20 planarization should result in greater uniformity of gap layer coverage of the P1 pole especially at the pole tip edges. Also, erosion problems associated with topography, and changes in topography, are reduced or eliminated, since the erosion rate over a planar surface
25 tends to be uniform, while the erosion rate at step edges tends to be accelerated.

 Planarization also reduces lithographic complexity in the pole tip region. In practice of the present invention, it is therefore possible to present a plateau,
30 rather than a valley/mesa combination with step edges, upon which subsequent structures can be deposited/exposed/developed. This improves critical dimension control by eliminating stray reflections off the step edges and allows generation of more vertically
35 walled P2 poles.

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As a result of the planarization layer, the gap layer assumes a uniform thickness over the entire P1 top surface, and if thinning occurs it does so uniformly over the entire gap layer during the successive steps of the process described above. The width of the second pole piece P2 then becomes independent of the width of pole P1, where the planarized gap layer is at least as wide as the overlaid P2 pole. Hence, when pole piece P2 is plated to be wider than or approximately equal to pole piece P1, no magnetic shorting occurs at the gap.

A preferred embodiment of the photoplanarization process is described with respect of FIGS. 4A-4D. In FIG. 4A, a P1 pole is shown on an insulating layer 48 upon a wafer 39 in practice of conventional process technology. In FIG. 4B, a positive photoresist (e.g. AZ1375) is spun on top of workpiece 39 of FIG. 4A, for example, at approximately 4,000 rpm in the case of a 3.0 micron thick P1 pole. The resist viscosity and spin speed affect the spun film thickness, and should be adjusted according to pole thickness t . Photoresist 40 will settle on and over the P1 pole and will assume approximately the configuration (in cross-section) as shown in FIG. 4B.

In the next step, photoresist 40 is pattern-wise exposed and developed as is well known to those practiced in microlithography using a photoresist border pattern mask 38 (shown in dotted outline in FIG. 4C). By virtue of this process, a resist border 42 is retained around the P1 pole, or at least at the pole tip region, after exposure and development. Border 42 overlaps the P1 pole in the tract width direction W , ultimately to insure a smooth transition from the pole top surface 32 to the planarized plateau P after further processing. As a result of the slight overlap of border 42, a raised portion of photoresist 40 will remain on top of pole P1

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after developing, as indicated in Fig. 4C by the slight shoulders 44 overriding the corners C1 and C2 of pole P1. Preferably each resist shoulder will overlap pole P1 by approximately one-quarter to one-half micron.

5. Photoresist 40 remaining on workpiece 39 is hard-baked thereafter. In this process, the resist will undergo thermal flow and cross-linking, and shoulders 44 atop the P1 pole corners C1, C2 will thin out by means of surface tension in the polymer as it passes the glass transition point. The result is a rather smooth-surfaced, chemically resistant plateau P. This plateau P, acting in concert with the top surface 32 of pole P1, yields substantially flat areas 45 and terminates with smoothly downward sloped outer walls 46 which merge with
- 10 insulating base layer 48, as seen in FIG. 4D. (This provides a substantially flat workpiece, however, a slight elevation may be experienced at the point where the photoresist meets flat area 45.) This structure is suitable for further processing, such as gap layer
- 15 deposition and plating of pole P2 (less than, equal to or wider than pole P1). In alternative embodiments, however, it may be desirable to lap the planarized surface P before further processing.

- Hard-baking of photoresist 40 is preferably
- 25 performed at 265°C, under vacuum with 10 cubic feet per hour nitrogen backfill. A magnetic field may also be applied during this process to effect desired anisotropic magnetic pole performance characteristics.

- Referring again to the spun on photoresist, it is
- 30 noted that too low a spin speed will result in minor smooth hard-baked photoresist "ears" at the edges of the P1 pole. This will provide a slightly thicker gap locally. Too high a spin speed will have less of an effect, but will result in sloping down of the entire
- 35 planarized surface as it extends away from pole P1 and

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will result in a sloping down of pole P2 formed thereover.

Alternative process steps may be followed in practice of the above photoplanarization invention. For example, polyimide has advantages over hard-baked photoresist in that it is less brittle, mechanically strong and highly chemically resistant. These properties are advantageous for a material which in the pole tip region would be submitted to mechanical processing and solvent cleaning. The disadvantages of polyimide, however, are that the material does not round the flow as well as photoresist, and additional process steps and final cure temperatures greater than 350° are required to fully imidize the polymer. This latter constraint may be mitigated by curing in an orienting magnetic field.

In one alternative process, a polyimide coating of a thickness equal to or slightly greater than the P1 pole piece thickness is spun onto the wafer and is partially cured. Positive resist is then spun onto the wafer and patterned using a mask similar to that described above. The polyimide is then patterned (in the partially cured state) via the positive resist using a hydroxide-based developer.

The wafer is then polished. For example, it can be inverted on a one-half micron (or less) grit, mylar mounted, fixed particle abrasive polishing media, and then the wafer is slightly pulled across the polishing media to remove excess resist from the top surface of the pole piece. A low amount of force is required to remove the soft-baked resist. Surface scratching should be avoided by using low polishing forces in low grit size, although the actual process may include a rough polish followed by polishing steps using increasingly finer grit size.

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In the next step, the polyimide is fully cured at 350°C.

In the processes described above, any positive acting photoresist may be used, such as AZ-1375, diazide sensitiz-
5 er, phenolic resin, etc. The resist used will depend upon the pole thickness to be planarized. Resists are available in different viscosity ranges, which will affect coating thickness. The spin coating speed will also depend upon resist type and desired thickness. In
10 our experience, we have found that coating thickness resulting on the wafer should be approximately 20% to 30% greater than the pole thickness being planarized in order to allow for volume shrinkage which will occur from hard baking. Also, after spin coating, a soft bake at 90°C
15 for 30 minutes is preferably performed to drive off resist coating solvents, which is a standard process procedure.

As a result of the foregoing, conventional thin film head fabrication may be modified to provide an
20 inexpensive, quick and high yield process for generation of magnetic thin film heads not otherwise practically possible heretofore. Thus, new configurations of the P2 pole equal to and wider than the P1 pole can be conveniently achieved.

25 The configuration of the pole tips in practice of the present invention can be of any desired combination. For example, a substantially rectangular portion adjacent to the gap and a substantially trapezoidal portion adjacent to the rectangular portion can be defined in
30 either or both of the pole tips, in order to minimize undershoots that result in the readback waveforms from thin film heads. Furthermore, it is recognized that other modifications and variations of the present invention will occur to those skilled in the art, and it

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is intended that all modifications and variations be
included within the scope of the appended claims.

What is claimed is:

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- 1 1. A magnetic transducer, comprising:
2 at least a functionally first pole,
3 at least a functionally second pole,
4 the tip of the second pole being formable over
5 the tip of the first pole regardless of relative pole
6 width and alignment.

- 1 2. The transducer of claim 1 wherein
2 the pole tips define a portion of an air-
3 bearing surface, the first pole disposed to interact with
4 a magnetic medium before the second pole interacts with
5 the medium, thus defining a longitudinal operational
6 direction for the head,
7 the poles separated by a gap section, the gap
8 section's width running substantially perpendicular to
9 the longitudinal direction, and
10 the gap section being at least as wide as the
11 second pole tip is wide.

- 1 3. The transducer of claim 2 wherein the second
2 pole is at least one micron wider than the first pole.

- 1 4. The transducer of claim 2 wherein the top
2 surface of the gap section and the top surface of the
3 first pole form a planarized work area wider than the top
4 surface of the first pole.

- 1 5. The transducer of claim 1 or 2 further
2 comprising a third pole, the third pole located in the
3 gap section.

- 1 6. The transducer of claim 2 wherein the third
2 pole tip is less wide than the first pole tip.

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1 7. The transducer of claim 2 wherein the poles
2 form a single structure and are connected distal to the
3 tips defining a yoke, the yoke including a coil structure
4 having at least a first and a second lead, the leads
5 coupleable to a source of electrical energy to complete
6 an energization circuit.

1 8. The transducer of claim 5 wherein at least the
2 first and second poles form a single structure and are
3 connected distal to the tips defining a yoke, the yoke
4 including a coil structure having at least a first, a
5 second, and a third lead, the leads coupleable to a
6 source of electrical energy to complete an energization
7 circuit.

1 9. A magnetic head with reduced topographical
2 steps/edges and reduced resultant spurious reflections
3 during lithographic processing, comprising:
4 a substrate,
5 an insulating layer over the substrate,
6 a first pole piece upon the layer,
7 a second pole piece,
8 a gap section,
9 the gap section intermediate and coupled to
10 the pole pieces, and
11 the gap section being at least about as wide
12 as the second pole piece and at least as wide as the
13 first pole piece.

1 10. The head of claim 9 wherein a planarizing
2 layer is defined upon the first pole piece, whereby the
3 first pole piece plus the planarizing layer is at least
4 about as wide as the second pole piece.

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1 11. The head of claim 10 wherein the planarizing
2 layer is comprised of Al_2O_3 , SiO_2 , photoresist or
3 polyimide.

1 12. A method for forming the poles of a thin film
2 head, the head having at least two poles separated by a
3 gap section, the steps comprising:

4 (a) forming a planarizing layer at the first
5 of the poles at its tip whereby a uniform planar area can
6 be defined at the pole tip and the planarizing layer,

7 (b) forming the gap section coupled to the
8 uniform planar area, and

9 (c) forming the second pole coupled to the
10 gap section.

1 13. The method of claim 12 wherein the
2 planarizing layer is comprised of photoresist material
3 and wherein step (a) includes hard baking the material.

1 14. The method of claim 12 wherein step (a)
2 includes forming a layer of insulating material adjacent
3 to and over the first pole and lapping the insulating
4 material such that the top surface of the first pole and
5 the insulating material conform to a single plane whereby
6 the uniform planar area is defined.

1 15. The method of claim 14 wherein the
2 planarizing layer is comprised of Al_2O_3 , SiO_2 or
3 polyimide.

1 16. The method of claim 12, wherein said
2 planarizing layer is comprised of polyimide, and wherein
3 step (a) includes baking and patterning said polyimide.

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1 17. In fabrication of a multilayer magnetic
2 device, where a first structure is formed on a workpiece
3 and serves as a base for a second structure, a process of
4 rendering the surface of the first structure capable of
5 supporting the second structure even if the second
6 structure is equal to or wider than the first structure,
7 and eliminating step/edges and spurious reflections
8 thereby, comprising the steps of:

9 A. applying a leveling material over the
10 surface of the first structure,

11 B. photo patterning the leveling material,
12 exposing and developing a desired portion of the first
13 structure, and

14 C. baking the workpiece and forming a
15 planarized plateau across and beyond the surface of the
16 first structure.

1 18. The process of claim 17 wherein the leveling
2 material is photoresist or polyimide and is spun on the
3 workpiece.

1 19. The process of claim 20 wherein

2 (a) the formed structure is first pole of a
3 magnetic transducer,

4 (b) the leveling material is positive photo
5 resist and is photo patterned using a resist border mask,
6 and

7 (c) a resist border mask is retained
8 extending over the first pole at least at the pole tip
9 region after exposure and development of the photoresist.

1 20. The process of claim 19 wherein the border
2 mask inner dimension is slightly smaller than that of the
3 plated pole tip.

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- 1 21. The process of claim 20 wherein the border
2 mask forms a shoulder over the first pole.
- 1 22. The process of claim 18 wherein the
2 photoresist is hard-baked at a temperature of
3 approximately 265°C.
- 1 23. The process of claim 18 wherein the polyimide
2 is hard-baked at a temperature of approximately 350°C.
- 1 24. The process of claim 22 further comprising
2 applying a vacuum with a 10 cubic feet per hour nitrogen
3 backfill in a magnetic field.
- 1 25. The process of claim 23 further comprising
2 applying a vacuum of with a 10 cubic feet per hour
3 nitrogen backfill in a magnetic field.
- 1 26. The process of claim 17 wherein step B
2 includes causing the leveling compound to overlap the
3 edges of the first structure by approximately one-quarter
4 to one-half micron.
- 1 27. The process of claim 17 wherein step/edges
2 are eliminated by the planarized plateau.
- 1 28. The process of claim 19 wherein the side
2 walls of the first pole are made substantially vertical.
- 1 29. In a head having a gap layer extending over
2 and possibly beyond the sides of pole, a method for
3 improving gap layer uniformity by preventing thinning of
4 the gap layer as the side corners of the pole during gap
5 layer formation, comprising the steps of:
6 (a) forming the pole on a substrate,

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- 8 (b) applying a leveling ~~material over and~~
9 beyond the surface of the pole, and
10 (c) forming the gap layer with the leveling
11 material over and possibly extending beyond the sides of
12 the pole.

1 30. A recording head to optimize high density
2 recording by reduction of hooks on ends of a transition,
3 comprising at least two poles with a gap section in
4 between and configured with the second pole and gap
5 section being greater in width than the first pole, the
6 second pole to first pole width ratio yielding low
7 transverse field components at the head field fringes,
8 whereby the transition becomes substantially parallel to
9 the gap section.

1 31. The head of claim 30 wherein the vertical
2 component of the head field, relative to horizontal
3 components, are minimized.

1 32. The head of claim 30 wherein the longitudinal
2 component of the head field is substantially parallel to
3 the gap section at the head field fringes.

1 33. The head of claim 30 having field
2 distribution which eliminates the hooks at the ends of a
3 transition.

1 34. The head of claim 33 wherein the transition
2 is defined parallel to the gap section.

1 35. The head of claim 31 wherein the vertical
2 component at the recording zone is reduced by about 35%
3 compared to the same device with the first pole wider
4 than the second pole.

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1 36. The head of claim 35 wherein the resultant
2 head field is about 50° out-of-plane.

1 37. The head of claim 36 further comprising a
2 third pole for readback embedded within the gap section.

1 38. The head of claim 36 wherein the readback
2 waveform is nearly symmetrical.

1 39. A method for optimizing high density
2 recording of transitions on a medium using a magnetic
3 head, comprising:
4 reducing transverse field components at the
5 head fringes, reducing the hooks on the ends of the
6 transitions, and reducing vertical components of the head
7 field, whereby in a sequence of recorded transitions,
8 each transition becomes substantially parallel to the
9 previous transaction as recorded on the medium.

1 40. The method of claim 39 wherein the head has
2 at least two poles with a gap section in between.

1 41. The method of claim 40 wherein the second
2 pole and gap section are greater in width than the first
3 pole.

1 42. The method of claim 41 wherein the second
2 pole is about one or more microns wider than the first
3 pole.

1 43. The method of claim 42 wherein the transverse
2 fields at the fringe zones are reduced approximately 35%
3 compared to if the first pole were greater in width than
4 the second pole.

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1 44. The method of claim 43 wherein the
2 longitudinal component of the head field is parallel to
3 the gap at the firing zones.

1 45. The method of claim 44 wherein the resultant
2 head field at the recording zone is only about 50° out-
3 of-plane.

1 46. The method of claim 45 further including
2 providing a symmetrical readback waveform with a third
3 pole embedded in the gap layer between the two poles, the
4 third pole saturating during writing and operating during
5 reading.

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